

Models 2634B, 2635B, and 2636B

Keithley Instruments 28775 Aurora Road Cleveland, Ohio 44139 1-800-833-9200 tek.com/keithley

System SourceMeter Instrument Specifications

SPECIFICATION CONDITIONS

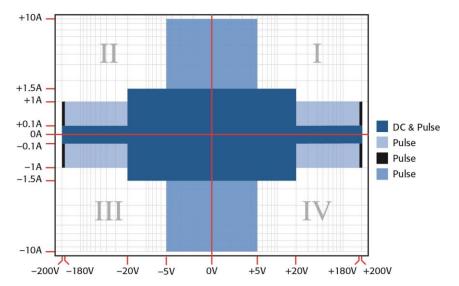
This document contains specifications and supplemental information for the Models 2634B, 2635B, and 2636B System SourceMeter™ instrument. Specifications are the standards against which the 2634B, 2635B, and 2636B are tested. Upon leaving the factory, the 2634B, 2635B, and 2636B meet these specifications. Supplemental and typical values are nonwarranted, apply at 23 °C, and are provided solely as useful information.

Source and measurement accuracies are specified at the 2634B, 2635B, and 2636B terminals under these conditions:

- 18 °C to 28 °C, < 70 percent relative humidity
- After a two-hour warm-up period
- Speed normal (1 NPLC)
- A/D autozero enabled
- Remote sense operation or properly zeroed local operation
- Calibration period: One year

DC POWER SPECIFICATIONS

	Voltage	Current
Maximum output	30.3 W maximum per channel	30.3 W maximum per channel
power and source/sink limits ¹	■ ± (20.2 V at 1.5 A, -1.5 A)	■ ± (1.515 A at 20 V, -20 V)
Source/Silik lilling	■ ± (202 V at 100 mA, -100 mA)	■ ± (101 mA at 200 V, -200 V)
	 Four-quadrant source or sink operation 	 Four-quadrant source or sink operation



Refer to Pulse Characteristics for pulsing details, such as duty cycle and pulse width.

Specifications are subject to change without notice



¹ Full power source operation regardless of load or number of channels used to 30 °C ambient temperature. Above 30 °C or power sink operation, refer to "Operating Boundaries" in the *Series 2600B System SourceMeter Reference Manual* for additional power derating information.

VOLTAGE ACCURACY SPECIFICATIONS^{2, 3}

	Source	ce			
Range	Programming resolution		Typical noise (Peak to peak) 0.1 Hz to 10 Hz	Display resolution	Accuracy ⁴ ± (% reading + volts)
200 mV	5 μV	0.02% + 375 μV	20 μV	100 nV	0.015% + 225 μV
2 V	50 μV	0.02% + 600 μV	50 μV	1 μV	0.02% + 350 μV
20 V	500 μV	0.02% + 5 mV	300 μV	10 µV	0.015% + 5 mV
200 V	5 mV	0.02% + 50 mV	2 mV	100 μV	0.015% + 50 mV

CURRENT ACCURACY SPECIFICATIONS²

	Source			Measure	
Range	Programming resolution	Accuracy ± (% reading + amperes)	Typical noise (Peak to peak) 0.1 Hz to 10 Hz	Display resolution	Accuracy ⁴ ± (% reading + amperes)
100 pA ⁵	N/A	N/A	N/A	100 aA	0.15% + 120 fA ^{6, 7}
1 nA	20 fA	0.15% + 2 pA	800 fA	1 fA	0.15% + 240 fA ^{6, 8}
10 nA	200 fA	0.15% + 5 pA	2 pA	10 fA	0.15% + 3 pA
100 nA	2 pA	0.06% + 50 pA	5 pA	100 fA	0.06% + 40 pA
1 μΑ	20 pA	0.03% + 700 pA	25 pA	1 pA	0.025% + 400 pA
10 µA	200 pA	0.03% + 5 nA	60 pA	10 pA	0.025% + 1.5 nA
100 µA	2 nA	0.03% + 60 nA	3 nA	100 pA	0.02% + 25 nA
1 mA	20 nA	0.03% + 300 nA	6 nA	1 nA	0.02% + 200 nA
10 mA	200 nA	0.03% + 6 μA	200 nA	10 nA	0.02% + 2.5 μA
100 mA	2 μΑ	0.03% + 30 μΑ	600 nA	100 nA	0.02% + 20 μA
1 A	20 μΑ	0.05% + 1.8 mA	70 μA	1 μΑ	0.03% + 1.5 mA
1.5 A	50 μΑ	0.06% + 4 mA	150 μΑ	1 μΑ	0.05% + 3.5 mA
10 A ⁹	200 μΑ	0.5% + 40 mA	N/A	10 μΑ	0.4% + 25 mA

² For temperatures 0 °C to 18 °C and 28 °C to 50 °C, accuracy is degraded by ± (0.15 × accuracy specification)/°C. High-Capacitance Mode accuracy is applicable at 23 °C ± 5 °C.

⁴ Derate accuracy specification for NPLC setting < 1 by increasing the error term. Add appropriate typical percent of reading term for resistive loads using the table below.

NPLC setting	PLC setting 200 mV range 2 V and 200 V rang		100 nA range 1 μA to 100 mA range		1 A to 1.5 A ranges	
0.1	0.01%	0.01%	0.01%	0.01%	0.01%	
0.01	0.08%	0.07%	0.1%	0.05%	0.05%	
0.001	0.8%	0.6%	1%	0.5%	1.1%	

⁵ The 100pA range is not available with the Model 2634B.

 $^{^{3}}$ Add 50 μV to source accuracy specifications per volt of HI lead drop.

^{6 10-}NLPC, 11-Point Median Filter, < 200 V range, measurements made within 1 hour after zeroing. 23 °C ± 1 °C.

⁷ Under default specification conditions: \pm (0.15% + 750 fA).

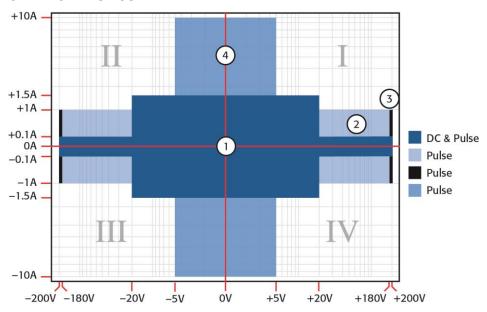
⁸ Under default specification conditions: \pm (0.15% + 1 pA).

⁹ 10 A range is accessible in pulse mode only. Accuracy specifications for 10 A range are typical.

SUPPLEMENTAL CHARACTERISTICS

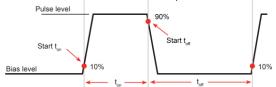
The following specifications are supplemental characteristics that provide additional information about instrument functions and performance. These characteristics are nonwarranted specifications; they describe the typical performance of the 2634B, 2635B, and 2636B.

PULSE CHARACTERISTICS



Pulse region specifications					
Region quadrant diagram	Region maximums	Maximum pulse width ¹⁰	Maximum duty cycle ¹¹		
1	100 mA at 200 V	DC, no limit	100%		
1	1.5 A at 20 V	DC, no limit	100%		
2	1 A at 180 V	8.5 ms	1%		
312	1 A at 200 V	2.2 ms	1%		
4	10 A at 5 V	1 ms	2.2%		

¹⁰ Times measured from the start of pulse to the start off-time; see figure below.



¹¹ Thermally limited in sink mode (quadrants 2 and 4) and ambient temperatures above 30 °C. See power equations in the *Series 2600B System SourceMeter Reference Manual* for more information.

Specifications are subject to change without notice

¹² Voltage source operation with 1.5 A current limit.

Minimum programmable pulse width ⁹	 100 μs Note: Minimum pulse width for settled source at a given I-V output and load can be longer than 100 μs. 					
	Source value	Load	Source settling time (% of range)	Minimum pulse width		
	5 V	0.5 Ω	1%	300 µs		
	20 V	200 Ω	0.2%	200 μs		
	180 V	180 Ω	0.2%	5 ms		
	200 V (1.5 A Limit)	200 Ω	0.2%	1.5 ms		
	100 mA	200 Ω	1%	200 μs		
	1 A	200 Ω	1%	500 μs		
	1 A	180 Ω	0.2%	5 ms		
	10 A	0.5 Ω	0.5%	300 µs		
Pulse width programming resolution	1 μs					
Pulse width programming accuracy	± 5 μs					
Pulse width jitter	2 µs					

ADDITIONAL SOURCE CHARACTERISTICS

< 20 mV peak to peak, < 3 mV RMS			
n load.			
mpliance			
Current:			
■ <±0.1%			
■ Step size = 10% to 90% of range, resistive load			
Voltage:			
Current: ¹³			

¹³ With source settling set to SETTLE_SMOOTH_100NA

 $^{^{14}}$ Add 50 μV to source accuracy specifications per volt of HI lead drop.

Voltage output headroom	200 V range				
	 Maximum output voltage = 202.3 V – (total voltage drop across source leads). Maximum 1 Ω source lead. 				
	20 V range				
	 Maximum output voltage = 23.3 V – (to Maximum 1 Ω source lead. 	otal voltage drop across source leads).			
Overtemperature protection	Internally sensed temperature overload put	ts the instrument in standby mode			
Limit/compliance	Bipolar limit (compliance) set with a single	value			
	Voltage: ¹⁵				
	 Minimum value is 20 mV; accuracy is 	the same as voltage source			
	Current: ¹⁶				
	 Minimum value is 100 pA; accuracy is 	the same as current source			
Voltage source output settling time	Time required to reach within 0.1% of final processed on a fixed range.	value after source level command is			
	Voltage range	Settling time			
	200 mV	< 50 µs			
	2 V	< 50 µs			
	20 V	< 110 μs			
	200 V	< 700 μs			
Current source output settling time	Time required to reach within 0.1% of final processed on a fixed range	value after source level command is			
	 Values below for I_{OUT} × R_{LOAD} = 2 V 	T			
	Current range	Settling time			
	1.5 A and 1 A	< 120 μs (R _{LOAD} > 6 Ω)			
	100 mA and 10 mA	< 80 µs			
	1 mA	< 100 µs			
	100 μΑ	< 150 μs			
	10 μΑ	< 500 µs			
	1 μΑ	< 2 ms			
	100 nA	< 20 ms			
	10 nA	< 40 ms			
	1 nA	< 150 ms			

¹⁵ For sink operation (quadrants II and IV) without sink mode enabled, add 10% of compliance range and ±0.02% of limit settling to the corresponding voltage source accuracy specifications. For 200 mV range add an additional 120 mV of uncertainty. Specifications apply with sink mode enabled.

¹⁶ For sink operation (quadrants II and IV) without sink mode enabled, add 0.06% of limit range to the corresponding current limit accuracy specifications. Specifications apply with sink mode enabled.

ADDITIONAL MEASUREMENT CHARACTERISTICS

Contact check specifications ^{17, 18}	Speed	Maximum measurement time to memory for 60 Hz (50 Hz)		Accuracy (1 year) 23 °C ± 5 °C ± (% reading + ohms)	
	Fast	1.1 ms (1.2 ms)		5% + 10 Ω	
	Medium	4.1 ms (5 ms)		5% + 1 Ω	
	Slow	36 ms (42 ms)		5% + 0.3 Ω	
Current measure settling time ¹⁹	· ·	e required to reach within 0.1% of final value after source level command is cessed on a fixed range			
	Values below for \	Vout = 2 V			
	Current range	rrent range Settling time			
	1 mA	< 100 μs		S	
Input impedance	> 100 TΩ				

ADDITIONAL CHARACTERISTICS

Maximum load impedance	Normal mode	High-capacitance mode			
	10 nF	50 μF			
Common mode voltage	250 V dc				
Common mode isolation	> 1 GΩ				
	< 4500 pF				
Sense high input impedance	> 100 TΩ				
Maximum sense lead resistance	1 kΩ for rated accuracy				
Overrange	101% of source range				
	102% of measure range				

¹⁷ Includes measurement of SENSE HI to HI and SENSE LO to LO contact resistances.

¹⁸ Contact check is not available with the Model 2634B.

 $^{^{\}rm 19}$ Compliance equal to 100 mA. Delay factor set to 1

HIGH-CAPACITANCE MODE^{20, 21, 22}

Accuracy specifications	Accuracy specifications are applicable in both normal and high-capacitance modes.			
Voltage source output settling time	Time required to reach within 0.1% of final value after source level command is processed on a fixed range.			
	Current limit = 1 A			
	Voltage range	Settling time with C _{LOAD} = 4.7 µF		
	200 mV	< 600 µs		
	2 V	< 600 µs		
	20 V	< 1.5 ms		
	200 V	< 20 ms		
Current measure settling time	Time required to reach within 0.1% of final processed on a fixed range	value after source level command is		
	Values below for V _{OUT} = 2 V unless noted			
	Current range	Settling time		
	1.5 A and 1A	< 120 μs (R _{LOAD} > 6 Ω)		
	100 mA and 10 mA	< 100 µs		
	1 mA	< 3 ms		
	100 μΑ	< 3 ms		
	10 μΑ	< 230 ms		
	1 μΑ	< 230 ms		
Capacitor leakage	200 ms at 50 nA			
performance using HIGH-C scripts ²³	■ Load = 5 μF in parallel with 10 MΩ			
Compto	■ Test: 5 V step and measure			
Mode change delay	Current ranges of 100 µA and above:			
	11 ms delay for both in and out of high	n-capacitance mode		
	Current ranges below 100 μA:			
	 250 ms delay into high-capacitance me 			
	 11 ms delay out of high-capacitance m 	node		
Voltmeter input impedance	$30~\text{G}\Omega$ in parallel with $3300~\text{pF}$			
Noise	< 30 mV peak to peak			
10 Hz to 20 MHz	■ 20 V range			
Range change overshoot	Voltage:			
	< 400 mV + 0.1% of larger range			
	For 20 V range and below			
	 Overshoot into a 200 kΩ load, 20 MHz 	bandwidth		

²⁰ High-Capacitance Mode specifications are for dc measurements only.

²¹ 100 nA range is not available in High-Capacitance Mode.

²² High-Capacitance Mode utilizes locked ranges. Auto range is disabled.

²³ Part of KI Factory scripts. See the Series 2600B Reference Manual for details.

MEASUREMENT SPEED CHARACTERISTICS^{24, 25, 26}

Maximum sweep operation rates (operations per second) for 60 Hz (50 Hz):

A/D converter speed	Trigger origin	Measure to memory	Measure to GPIB	Source measure to memory	Source measure to GPIB	Source measure to memory	Source measure to GPIB
		(using user scripts)	(using user scripts)	(using user scripts)	(using user scripts)	(using sweep API)	(using sweep API)
0.001 NPLC	Internal	20000 (20000)	9800 (9800)	7000 (7000)	6200 (6200)	12000 (12000)	5900 (5900)
0.001 NPLC	Digital I/O	8100 (8100)	7100 (7100)	5500 (5500)	5100 (5100)	11200 (11200)	5700 (5700)
0.01 NPLC	Internal	4900 (4000)	3900 (3400)	3400 (3000)	3200 (2900)	4200 (3700)	4000 (3500)
0.01 NPLC	Digital I/O	3500 (3100)	3400 (3000)	3000 (2700)	2900 (2600)	4150 (3650)	3800 (3400)
0.1 NPLC	Internal	580 (480)	560 (470)	550 (465)	550 (460)	560 (470)	545 (460)
0.1 NPLC	Digital I/O	550 (460)	550 (460)	540 (450)	540 (450)	560 (470)	545 (460)
1.0 NPLC	Internal	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)
1.0 NPLC	Digital I/O	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)

Maximum single measurement rates (operations per second) for 60 Hz (50 Hz):

A/D converter speed	Trigger origin	Measure to GPIB	Source measure to GPIB	Source measure pass/fail to GPIB
0.001 NPLC	Internal	1900 (1800)	1400 (1400)	1400 (1400)
0.01 NPLC	Internal	1450 (1400)	1200 (1200)	1100 (1100)
0.1 NPLC	Internal	450 (390)	425 (370)	425 (375)
1.0 NPLC	Internal	58 (48)	57 (48)	57 (48)

²⁴ Tests performed with a Model 2636B using the following equipment: Computer hardware (Intel[®] Pentium[®] 4 2.4 GHz, 2 GB RAM, National Instruments[™] PCI-GPIB); driver (NI-488.2 Version 2.2 PCI-GPIB); software (Microsoft[®] Windows[®] XP, Microsoft[®] Visual Studio[®] 2010, VISA[™] version 4.1).

²⁵ Exclude current measurement ranges less than 1 mA.

²⁶ With default measurement delays and filters disabled.

Maximum measurement range change rate	> 7000 per second for > 10 µA. When changing to or from a range ≥ 1 A, maximum rate is > 2200/second.
Maximum source range change rate	> 400 per second > 10 µA. When changing to or from a range ≥ 1 A, maximum rate is > 190/second.
Maximum source function change rate	> 1000 per second
Command processing time	< 1 ms
	 Maximum time required for the output to begin to change after receiving the smua.source.levelv or smua.source.leveli command.

TRIGGERING AND SYNCHRONIZATION CHARACTERISTICS

Triggering

Trigger in to trigger out	0.5 μs
Trigger in to source change ²⁷	10 μs
Trigger timer accuracy	±2 µs
Source change ²⁷ after LXI trigger	280 μs

Synchronization

Multi-node synchronized source change ²⁷	< 0.5 μs
Single-node synchronized source change ²⁷	< 0.5 µs

²⁷ Fixed source range with no polarity change.

SUPPLEMENTAL INFORMATION

Front-panel interface	Two-line vacuum fluorescent display (VFD) with keypad and navigation wheel	
Display	 Show error messages and user-defined messages Display source and limit settings Show current and voltage measurements View measurements stored in dedicated reading buffers 	
Keypad operations	 Change host interface settings Save and restore instrument setups Load and run factory and user-defined test scripts that prompt for input and send results to the display Store measurements into dedicated reading buffers 	
Programming	Embedded Test Script Processor (TSP™) accessible from any host interface; responds to high-speed test scripts comprised of remote commands and statements (for example, branching, looping, and math); able to execute test scripts stored in memory without host intervention.	
Minimum user memory available	16 MB (approximately 250,000 lines of TSP code)	
Reading buffers	Nonvolatile memory uses dedicated storage areas reserved for measurement data. Reading buffers are arrays of measurement elements. Each element can store the following items:	
	 Measurement 	
	Source setting (at the time the measurement was taken)	
	Measurement status	
	Range information	
	■ Timestamp	
	Reading buffers can be filled using the front-panel STORE key, and retrieved using the RECALL key or host interface.	
Buffer size, with timestamp and source setting	> 60,000 samples	
Buffer size, without timestamp and source setting	> 140,000 samples	

TIMING

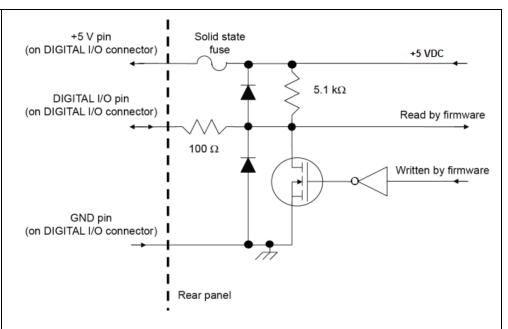
Timer	Free-running 47-bit counter with 1 MHz clock input. Reset each time instrument power is turned on. If the instrument is not turned off, the timer is automatically reset to zero (0) every four years.
Timestamp	TIMER value is automatically saved when each measurement is triggered
Resolution	1 µs
Timestamp accuracy	±100 ppm

GENERAL SPECIFICATIONS

IEEE-488	IEEE Std 488.1 compliant. Supports IEEE Std 488.2 common commands and status model topology	
RS-232	 Baud rates from 300 bps to 115,200 bps Programmable number of data bits, parity type, and flow control (RTS/CTS hardware or none) When not programmed as the active host interface, the 2634B, 2635B, and 2636B can use the RS-232 interface to control other instruments 	
Ethernet	RJ-45 connector, LXI version 1.4 Core 2011, 10/100BaseT, Auto-MDIX	
LXI compliance	LXI version 1.4 Core 2011	
Expansion interface ²⁸	 The TSP-Link™ expansion interface allows TSP-enabled instruments to trigger and communicate with each other Cable type: Category 5e or higher LAN crossover cable Three meter (9.84 ft) maximum between each TSP-enabled instrument 	
	A maximum of 32 TSP-Link nodes can be interconnected	
USB Control (Rear)	 Each source-measure instrument uses one TSP-Link node USB 2.0 Device: USB-TMC488 protocol 	
USB File System (Front)	USB 2.0 Host: Mass storage class device	
Power supply	100 V ac to 240 V ac, 50 Hz or 60 Hz (auto sensing), 240 VA maximum	
Cooling	Forced air; side intake and rear exhaust. One side must be unobstructed when rack mounted.	
Warranty	1 year	
EMC	Conforms to European Union EMC Directive	
Safety	NRTL listed to UL61010-1:2008 and CSA C22.2 No. 61010-1	
	Conforms to European Union Low Voltage Directive	
Environment	For indoor use only	
	Altitude: Maximum 2000 m (6562 ft) above sea level	
	Operating: 0 °C to 50 °C, 70% relative humidity up to 35 °C. Derate 3% relative humidity/°C, 35 °C to 50 °C	
	Storage: −25 °C to 65 °C	
Dimensions	Rack mount: 89 mm high × 213 mm wide × 460 mm deep (3.5 in. × 8.4 in. × 17.5 in.)	
	Bench configuration (with handle and feet): 104 mm high \times 238 mm wide \times 460 mm deep (4.1 in. \times 9.4 in. \times 17.5 in.)	
Weight	2635B: 4.75 kg (10.4 lb)	
	2634B and 2636B: 5.50 kg (12.0 lb)	

²⁸ TSP-Link is not available with the Model 2634B.

Digital I/O interface²⁹



Connector: 25-pin female D

Input/output pins: 14 open drain I/O bits

Absolute maximum input voltage: 5.25 V

Absolute minimum input voltage: -0.25 V

Maximum logic low input voltage: 0.7 V, +850 µA maximum

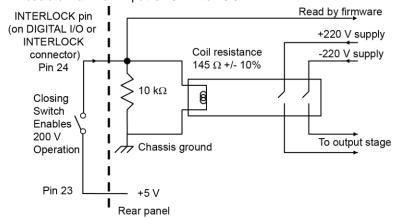
Minimum logic high input voltage: 2.1 V, +570 µA

Maximum source current (flowing out of digital I/O bit): $+960 \mu$ A Maximum sink current at maximum logic low voltage (0.7): -5.0μ A Absolute maximum sink current (flowing into digital I/O pin: -11μ A 5 V power supply pins: Limited to 250 mA total, solid-state fuse protected

Safety interlock pin:

A signal of > 3.4 V at 24 mA (at an absolute maximum of 6 V) must be externally applied to ensure 200 V operation. Connect the 5 V output and the interlock input of the 25-pin digital I/O connector on the back of the 2634B, 2635B, or 2636B to the switch in your fixture. The output will be disabled when the interlock signal is

< 0.45 V. Absolute maximum input is -0.4 V to +6.0 V.



²⁹ The Digital I/O feature is not available with the 2634B. Only +5 V, GND, and INTERLOCK pins are available with the Model 2634B.

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